



CHENMKO ENTERPRISE CO.,LTD

SMD26APT

SURFACE MOUNT

SCHOTTKY BARRIER RECTIFIER

VOLTAGE RANGE 60 Volts CURRENT 2.0 Ampere

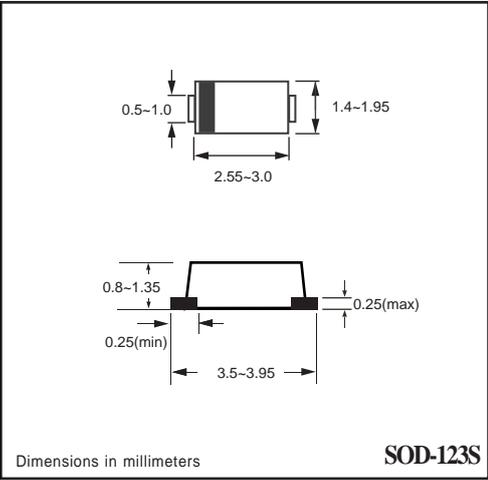
Lead free devices

FEATURES

- * For surface mounted applications
- * Metal silicon junction, majority carrier conduction
- * Low power loss, high efficiency
- * High current capability, low forward voltage drop
- * High surge capability
- * For use in low voltage high frequency inverters, free wheeling, and polarity protection applications
- * Lead free devices

MARKING

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CIRCUIT



MAXIMUM RATINGS (At TA = 25°C unless otherwise noted)

RATINGS	SYMBOL	SMD26APT	UNITS
Maximum Recurrent Peak Reverse Voltage	VRRM	60	Volts
Maximum RMS Voltage	VRMS	42	Volts
Maximum DC Blocking Voltage	VDC	60	Volts
Maximum Average Forward Rectified Current	Io	2.0	Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	IFSM	50	Amps
Typical Junction Capacitance (Note 2)	CJ	110	pF
Typical Thermal Resistance (Note 1)	RθJL	60	°C / W
Operating Temperature Range	TJ	-65 to +125	°C
Storage Temperature Range	TSTG	-65 to +150	°C

ELECTRICAL CHARACTERISTICS (At TA = 25°C unless otherwise noted)

CHARACTERISTICS	SYMBOL	SMD26APT	UNITS
Maximum Instantaneous Forward Voltage at 2.0 A DC	VF	0.65	Volts
Maximum Average Reverse Current at Rated DC Blocking Voltage	@ TA = 25°C	50	uAmps
	@ TA = 100°C	10	mAmps

NOTES : 1. Thermal Resistance (Junction to Lead) : PC Board Mounted on 0.2 X 0.2" (5 X 5mm) copper pad area.
2. Measured at 1.0 MHz and applied reverse voltage of 4.0 volts.

2007-06

RATING CHARACTERISTIC CURVES (SMD26APT)

FIG. 1 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

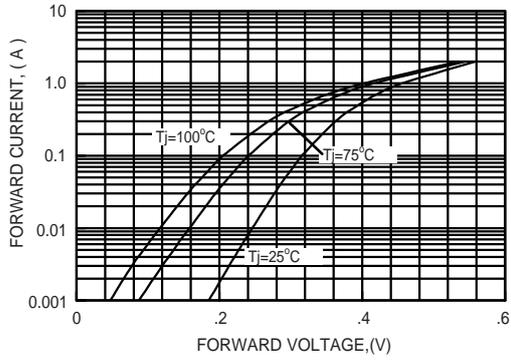


FIG. 2 - TYPICAL REVERSE CHARACTERISTICS

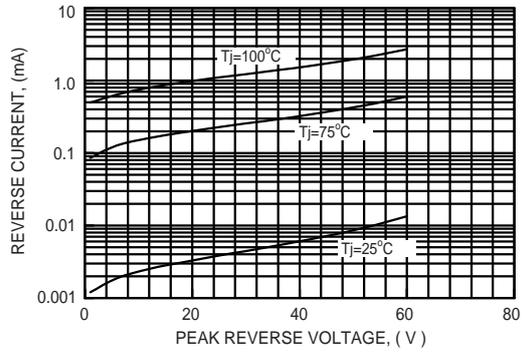


FIG. 3 - TYPICAL JUNCTION CAPACITANCE

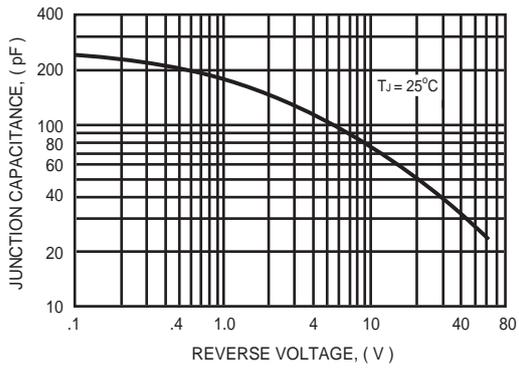


FIG. 4 - MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

